

December 2013

# FDP5800 N-Channel Logic Level PowerTrench<sup>®</sup> MOSFET 60 V, 80 A, 6 m $\Omega$

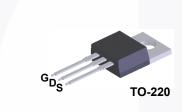
## Features

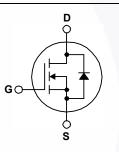
- R<sub>DS(on)</sub> = 4.6 mΩ (Typ.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 80 A
- + High Performance Trench Technology for Extermly Low  $R_{\text{DS}(\text{on})}$
- Low Gate Charge
- · High Power and Current Handing Capability
- RoHS Compliant

# Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

- Applications
- Power Tools
- Motor Drives and Uninterruptible Power Supplies
- Synchronous Rectification
- Battery Protection Circuit





# MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter			FDP5800	Unit
V <sub>DSS</sub>	Drain-Source Voltage			60	V
V <sub>GSS</sub>	Gate-Source Voltage			±20	V
I <sub>D</sub>		- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		80	A
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		80*	Α
		- Continuous (T <sub>A</sub> = 25 <sup>o</sup> C)		14	А
I <sub>DM</sub>	Drain Current - Pulsed			320	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 1)		(Note 1)	652	mJ
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> = 25 <sup>o</sup> C) - Derate Above 25 <sup>o</sup> C			242 1.61	W W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +175	°C

\*Drain current limited by package.

# **Thermal Characteristics**

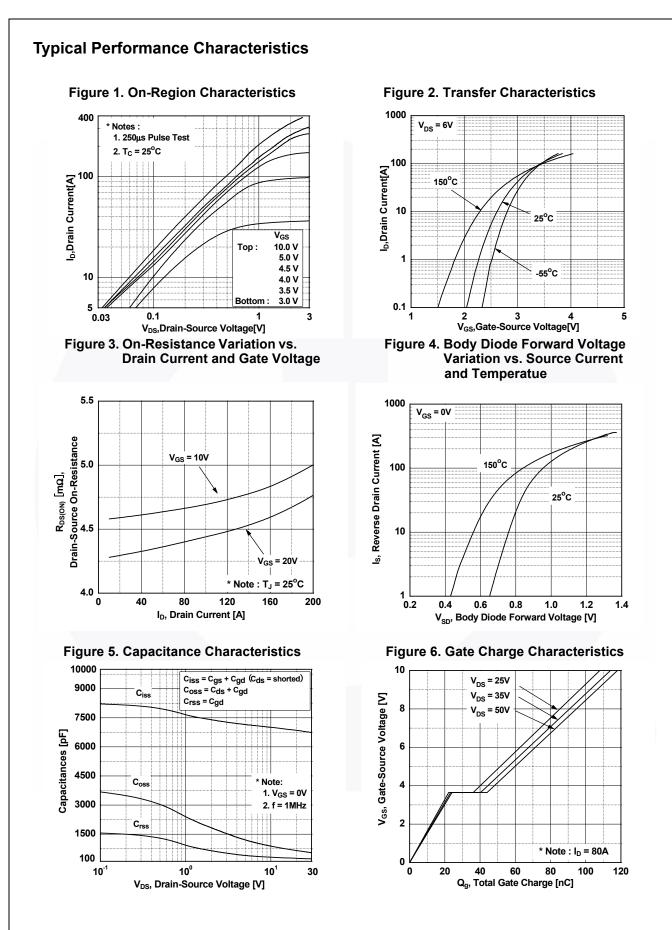
Symbol	Parameter	FDP5800	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.62	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	-0/00

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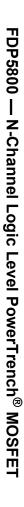
		Package	kage Packing Method Reel Size		Reel Size	Та	pe Width	Qua	antity	
		TO-220	Tube		N/A		N/A	50 units		
Electrica	l Chara	acteristics T <sub>c</sub> = 2	25°C unless o	therwise noted.						
Symbol		Parameter		Conditions			Min.	Тур.	Max.	Unit
Off Charac	cteristics	3								
B <sub>VDSS</sub>	Drain-So	Drain-Source Breakdown Voltage		I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V, T <sub>J</sub> =25 <sup>o</sup> C			60			V
				V <sub>DS</sub> = 48 V		,			1	μA
I <sub>DSS</sub> Zero Ga		Gate Voltage Drain Current		$V_{GS} = 0 V$	T <sub>J</sub> = 150°C				500	μA
I <sub>GSS</sub>	Gate-Bo	dy Leakage Current, F	orward	$V_{GS}$ = ±20 V, $V_{DS}$	= 0 V				±100	nA
On Charac	torictics								1	_
					0500		1.0		2.5	V
V <sub>GS(th)</sub>	Gale III	Gate Threshold Voltage		$V_{GS} = V_{DS}, I_D = 250 \mu\text{A}$ $V_{GS} = 10 \text{V}, I_D = 80 \text{A}$					-	
				$V_{GS} = 10 V$ , $I_{D} = V_{GS} = 4.5 V$ , $I_{D} =$				4.6 5.9	6.0 7.2	mΩ mΩ
Pass	Static Drain-Source On Resistance		ance	V <sub>GS</sub> = 4.5 V , I <sub>D</sub> = V <sub>GS</sub> = 5 V , I <sub>D</sub> = 8				5.9	7.2	mΩ
R <sub>DS(on)</sub>	Clario Di			$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 80 \text{ A},$				5.0	7.0	11152
				$T_{\rm J} = 175^{\rm o}{\rm C}$				10.4	12.6	mΩ
Dynamic C	Characte	ristics								-
C <sub>iss</sub>	Input Capacitance							6890	9160	pF
C <sub>oss</sub>	Output C	Capacitance		V <sub>DS</sub> = 15 V,V <sub>GS</sub> = 0 V, f = 1 MHz			750	1000	pF	
C <sub>rss</sub>	Reverse	Transfer Capacitance					295	445	pF	
R <sub>G</sub>	Gate Re	sistance		V <sub>GS</sub> = 0.5 V, f =	1 MHz			1.2		Ω
Q <sub>g(TOT)</sub>	Total Ga	te Charge at 10V		V <sub>GS</sub> = 0 V to 10	V			112	145	nC
Q <sub>g(TH)</sub>	Total Ga	te Charge at 5V		$V_{GS}$ = 0 V to 5 V				58		nC
Q <sub>g(TH)</sub>	Thresho	ld Gate Charge		$V_{GS} = 0 V \text{ to } 1 V$	V <sub>DS</sub> =	= 30 V,		7.0		nC
Q <sub>gs</sub>	Gate to	Source Gate Charge			$I_D = 80 \text{ A},$ $I_g = 1 \text{ mA}$			23		nC
Q <sub>gs2</sub>	Gate Ch	arge Threshold to Plat	eau					13		nC
Q <sub>gd</sub>	Gate to	Drain "Miller" Charge						18		nC
Switching	Charact	teristics (V <sub>GS</sub> = 10V	)							
t <sub>ON</sub>	Turn-On	Turn-On Time				/	37	85	ns	
t <sub>d(on)</sub>	Turn-On	Delay Time		$V_{DD}$ = 30 V, I <sub>D</sub> = 80 A, V <sub>GS</sub> = 10 V, R <sub>G</sub> = 1.5 Ω				18	46	ns
t <sub>r</sub>	Turn-On	Rise Time						19	47	ns
t <sub>d(off)</sub>		Delay Time						55	120	ns
t <sub>f</sub>	Turn-Off	Fall Time					9	28	ns	
t <sub>OFF</sub>	Turn-Off	Turn-Off Time						64	138	ns
	rce Diod	le Characteristics	s							
				V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 80 A					1.25	V
V <sub>SD</sub>	Drain-Sc	ource Diode Forward \	/oltage	$V_{GS} = 0 V, I_{SD} =$					1.0	V
t <sub>rr</sub>	Reverse	Recovery Time		$V_{GS} = 0 V, I_{SD} =$				58		ns
Q <sub>rr</sub>		Recovery Charge		$dl_{F}/dt = 100 A/\mu s$			106		nC	

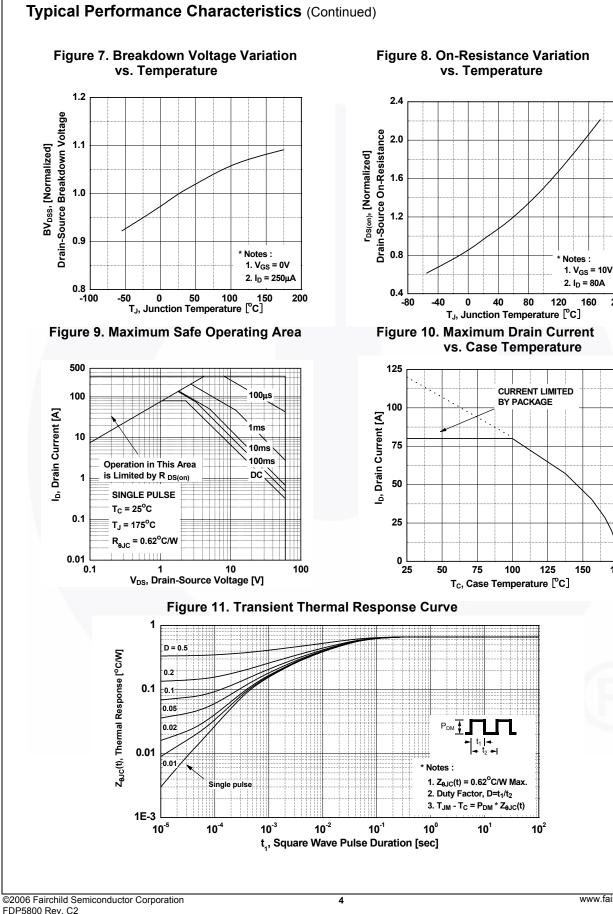
Notes: 1: L = 1 mH, I<sub>AS</sub> = 36 A, V<sub>DD</sub> = 54 V, V<sub>GS</sub> = 10 V, R<sub>G</sub> = 25  $\Omega$ , Starting T<sub>J</sub> = 25<sup>o</sup>C

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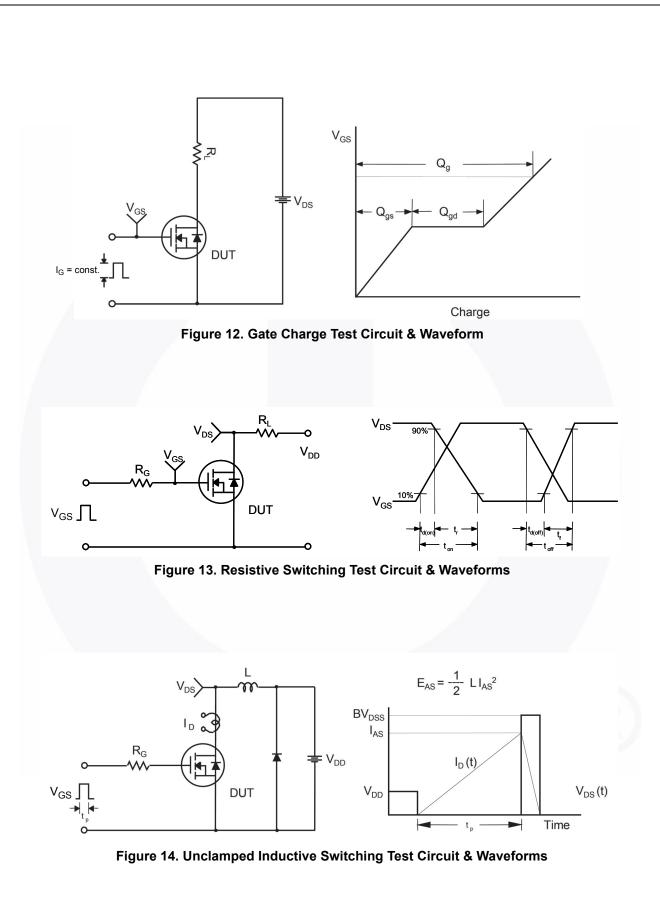


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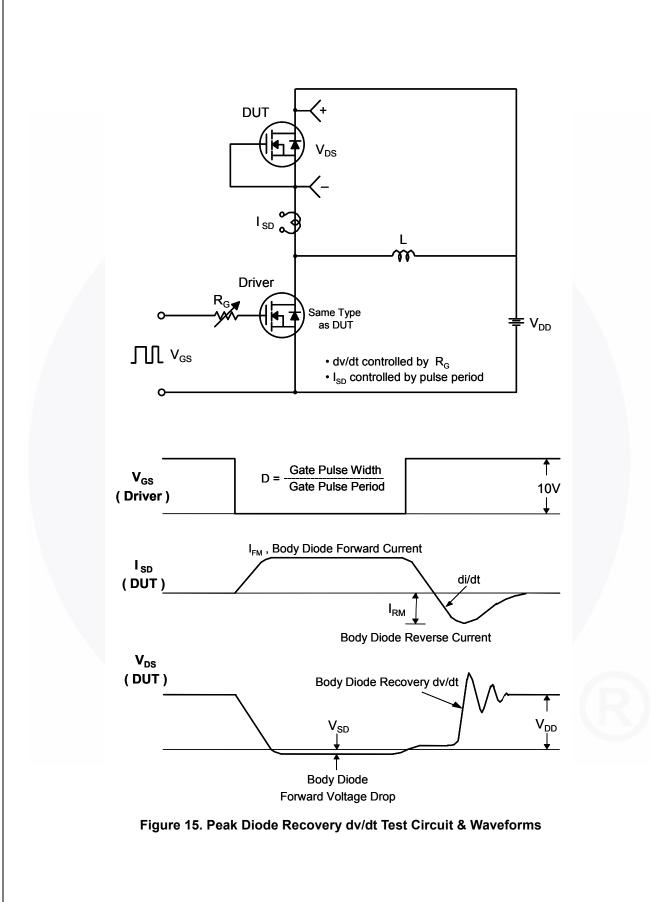


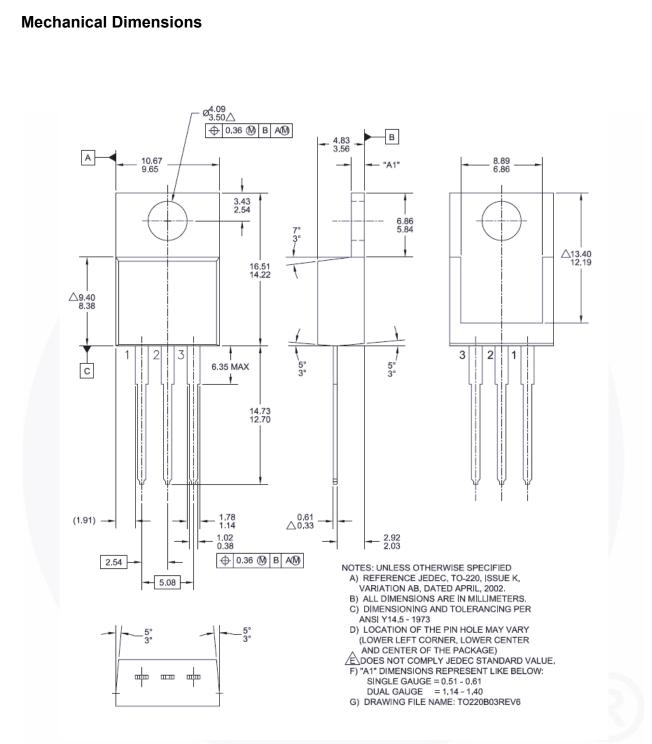


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FDP5800 — N-Channel Logic Level PowerTrench<sup>®</sup> MOSFET





### Figure 16. TO-220, Molded, 3-Lead, Jedec Variation AB

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